

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-to-Source Voltage		40	V
V _{GS}	Gate-to-Source Voltage		±20	V
I _D	Drain Current - Continuous (V _{GS} =10) (Note 1)	T _C =25°C	20	Α
	Pulsed Drain Current	T _C = 25°C	See Figure 4	— A
E _{AS}	Single Pulse Avalanche Energy	(Note 2)	98	mJ
р	Power Dissipation		75	W
P _D	Derate Above 25°C		0.5	W/ºC
T _J , T _{STG}	Operating and Storage Temperature		-55 to + 175	°C
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case		2	°C/W
$R_{ extsf{ heta}JA}$	Maximum Thermal Resistance, Junction to Ambient	(Note 3)	50	°C/W

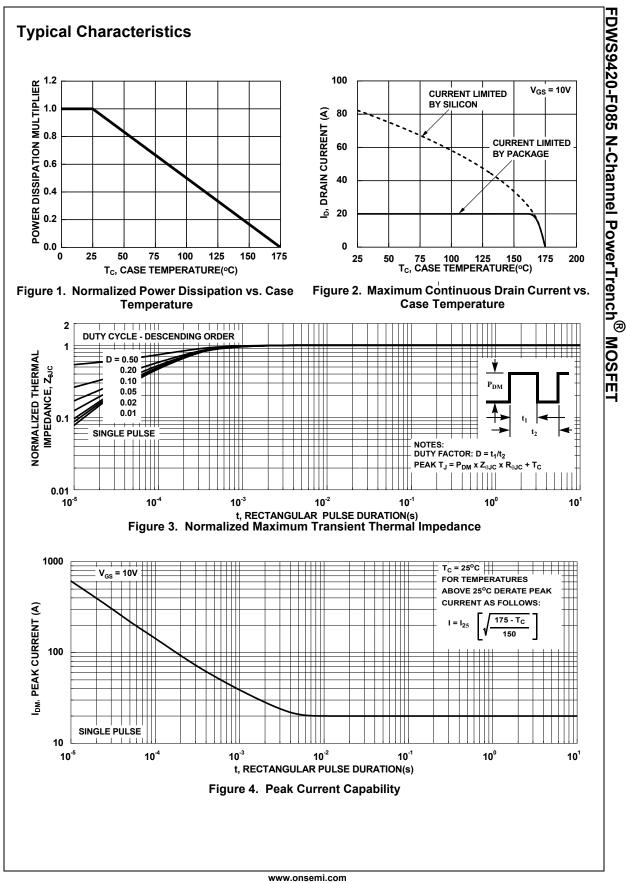
Notes:

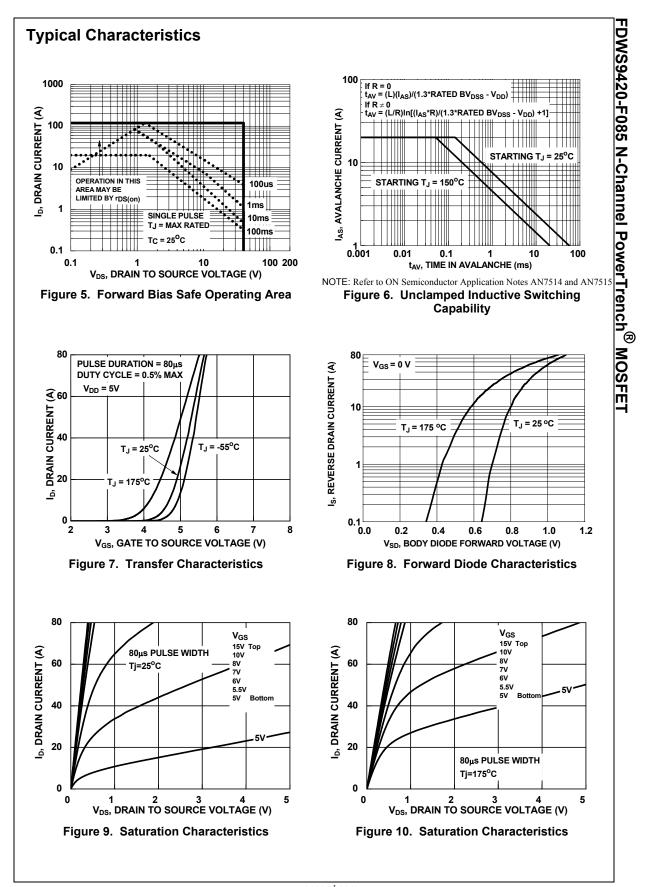
1: Current is limited by bondwire configuration. 2: Starting $T_J = 25^{\circ}$ C, L = 1mH, I_{AS} = 14A, V_{DD} = 40V during inductor charging and V_{DD} = 0V during time in avalanche. 3: R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder 3: R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder 3: R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder 3: R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance. moduling surface of the drain pins. $R_{\theta,JC}$ is guaranteed by design, while $R_{\theta,JA}$ is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.

Package Marking and Ordering Information

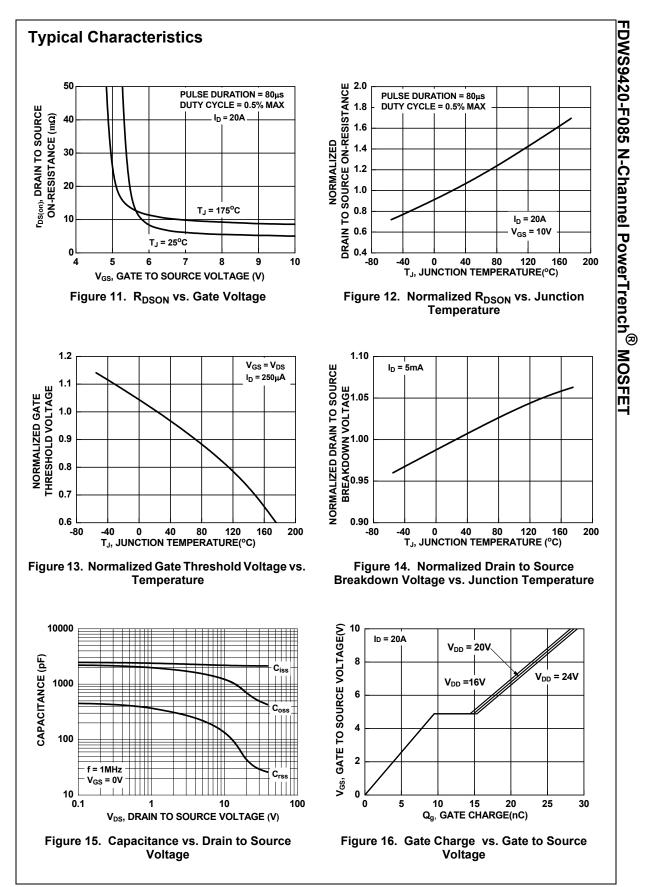
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDWS9420	FDWS9420-F085	Power56	13"	12mm	3000units

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Units
Off Cha	racteristics						
B _{VDSS}	Drain-to-Source Breakdown Voltage	I _D = 250μA, V _{GS}	= 0V	40	-	-	V
	-	$V_{DS} = 40V, T_J = 25^{\circ}C$		-	-	1	μA
IDSS	Drain-to-Source Leakage Current	$V_{GS} = 0V T_J$	= 175 ^o C (Note 4)	-	-	1	mA
I _{GSS}	Gate-to-Source Leakage Current	V _{GS} = ±20V		-	-	±100	nA
On Cha	racteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D =$	250μΑ	2.0	3.0	4.0	V
R _{DS(on)}	Drain to Source On Resistance		= 25°C	-	5.0	5.8	mΩ
			= 175°C (Note 4)	-	8.5	10.0	mΩ
-	ic Characteristics				0400		-
C _{iss}	Input Capacitance	$V_{DS} = 20V, V_{GS} = 0V,$ f = 1MHz		-	2100	-	pF
C _{oss}	Output Capacitance			-	710	-	pF
C _{rss}	Reverse Transfer Capacitance			-	44	-	pF
R _g	Gate Resistance	f = 1MHz		-	1.8	-	Ω
Q _{g(ToT)}	Total Gate Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DD} = 20V$		-	29	43	nC
Q _{g(th)}	Threshold Gate Charge	V_{GS} = 0 to 2V	I _D = 20A	-	3.9	-	nC
Q _{gs}	Gate-to-Source Gate Charge			-	9.5	-	nC
Q _{gd}	Gate-to-Drain "Miller" Charge			-	5.4	-	nC
Switchi	ng Characteristics						
t _{on}	Turn-On Time			-	-	29	ns
t _{d(on)}	Turn-On Delay			-	14	-	ns
t _r	Rise Time	$V_{DD} = 20V, I_D = 20A,$ $V_{GS} = 10V, R_{GEN} = 6\Omega$		-	8	-	ns
t _{d(off)}	Turn-Off Delay			-	21	-	ns
t _f	Fall Time			-	6	-	ns
t _{off}	Turn-Off Time			-	-	35	ns
Drain-S	ource Diode Characteristics						
Var	Source-to-Drain Diode Voltage	I _{SD} =20A, V _{GS} = 0V		-	-	1.25	V
V_{SD}		I_{SD} = 10A, V_{GS} =	= 0V	-	-	1.2	V
t _{rr}	Reverse-Recovery Time	$I_F = 20A, dI_{SD}/c$	lt = 100Α/μs	-	48	63	ns
Q _{rr}	Reverse-Recovery Charge	$V_{DD} = 32V$		-	40	52	nC

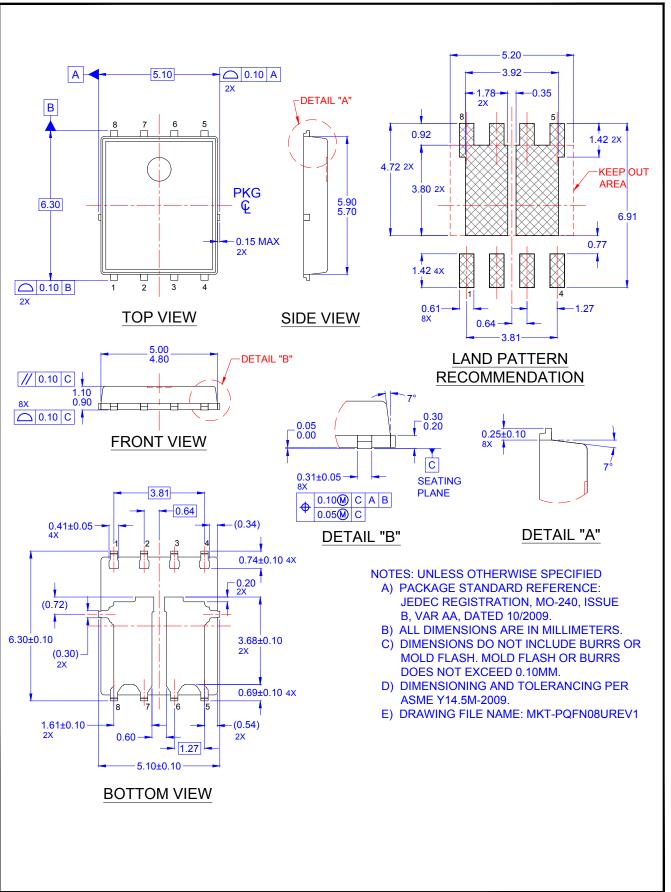




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